

DOMAMID® 66ST2F

Polyamide 66, improved impact resistance, for injection moulding.

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TYPICAL PROPERTIES	CONDITION	STANDARD	UNIT	VALUE
PHYSICAL				
Density		ISO 1183	[g/cm ³]	1,11
MECHANICAL				
Tensile modulus	1 mm/min	ISO 527	[MPa]	2200
Tensile strain at break	50 mm/min	ISO 527	[%]	55
Tensile stress at yield	50 mm/min	ISO 527	[MPa]	60
Tensile strain at yield	50 mm/min	ISO 527	[%]	10
Izod impact notched	+23 °C	ISO 180/1A	[kJ/m ²]	35
THERMAL				
Melting point	DSC	ISO 11357-1	[°C]	260 ± 2
ELECTRICAL				
Volume resistivity		IEC 93	[Ω·cm]	10 ¹⁵
Surface resistivity		IEC 93	[Ω]	10 ¹³
BURNING BEHAVIOUR				
Flammability	0,8 mm	UL 94	[Class]	HB

Test run at 23°C if not differently specified, DAM state (dry as moulded), valid for natural colored products

PROCESSING CONDITIONS:

Drying temperature/time	: 75-85°C/4-6h
Recommended melt temperature	: 260-285 °C
Recommended mould temperature	: 80 °C

These parameters are typical of the product but should be related to the type of machinery used and to the type of moulded part.

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